

HIGH-SPEED 32K x 16 DUAL-PORT STATIC RAM

IDT7027S/L

Features

- True Dual-Ported memory cells which allow simultaneous access of the same memory location
- High-speed access
 - Military: 25/35/55ns (max)Industrial: 25ns (max.)
 - Commercial: 20/25/35/55ns (max.)
- Low-power operation
 - IDT7027S

Active: 750mW (typ.) Standby: 5mW (typ.)

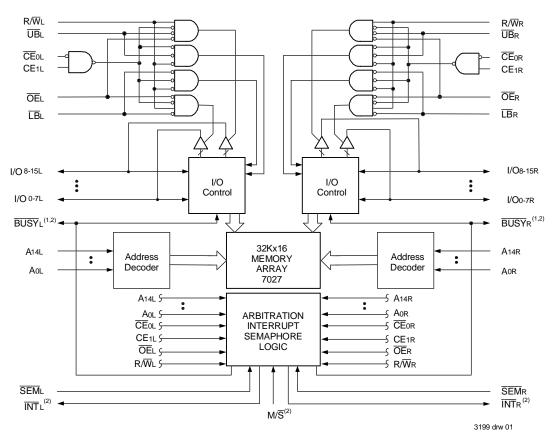
- IDT7027L

Active: 750mW (typ.) Standby: 1mW (typ.)

- Separate upper-byte and lower-byte control for bus matching capability.
- Dual chip enables allow for depth expansion without

- external logic
- IDT7027 easily expands data bus width to 32 bits or more using the Master/Slave select when cascading more than one device
- M/S = VIH for BUSY output flag on Master,
 - $M/\overline{S} = VIL \text{ for } \overline{BUSY} \text{ input on Slave}$
- Busy and Interrupt Flags
- On-chip port arbitration logic
- Full on-chip hardware support of semaphore signaling between ports
- Fully asynchronous operation from either port
- TTL-compatible, single 5V (±10%) power supply
- Available in 100-pin Thin Quad Flatpack (TQFP) and 108-pin Ceramic Pin Grid Array (PGA)
- Industrial temperature range (-40°C to +85°C) is available for selected speeds

Functional Block Diagram



NOTES:

- 1. BUSY is an input as a Slave (M/S=VIL) and an output as a Master (M/S=VIH).
- 2. $\overline{\text{BUSY}}$ and $\overline{\text{INT}}$ are non-tri-state totem-pole outputs (push-pull).

MAY 2000

Description

The IDT7027 is a high-speed 32K x 16 Dual-Port Static RAM, designed to be used as a stand-alone 512K-bit Dual-Port RAM or as a combination MASTER/SLAVE Dual-Port RAM for 32-bit-or-more word systems. Using the IDT MASTER/SLAVE Dual-Port RAM approach in 32-bit or wider memory system applications results in full-speed, error-free operation without the need for additional discrete logic.

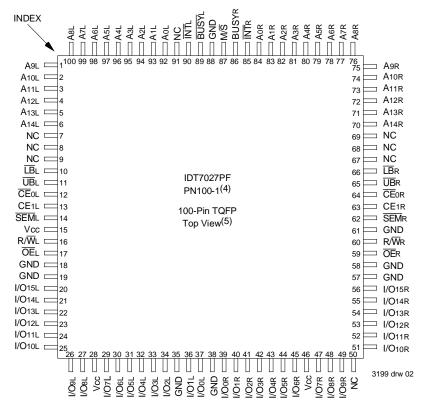
The device provides two independent ports with separate control, address, and I/O pins that permit independent, asynchronous access for reads or writes to any location in memory. An automatic power down feature controlled by the chip enables (CEo and CE1) permits the on-chip

circuitry of each port to enter a very low standby power mode.

Fabricated using IDT's CMOS high-performance technology, these devices typically operate on only 750mW of power. The IDT7027 is packaged in a 100-pin Thin Quad Flatpack (TQFP) and a 108-pin ceramic Pin Grid Array (PGA).

Military grade product is manufactured in compliance with the latest revision of MIL-PRF-38535 QML, making it ideally suited to military temperature applications demanding the highest level of performance and reliability.

Pin Configurations (1,2,3)



- 1. All Vcc pins must be connected to power supply.
- 2. All GND pins must be connected to ground supply.
- 3. Package body is approximately 14mm x 14mm x 1.4mm.
- 4. This package code is used to reference the package diagram.
- This text does not indicate orientation of the actual part-marking.

Pin Configurations^(1,2,3) (con't.)

12	81 A10R	80 A11R	77 A14R	74 NC	72 <u>UB</u> R	69 SEMR	68 GND	65 GND	63 NC	60 I/O13R	57 I/O10R	54 NC
11	84 A 7R	83 A 8R	78 A13R	76 NC	73 <u>LB</u> R	70 CE1R	67 R/WR	64 GND	61 I/O14R	59 I/O12R	56 I/O9R	53 NC
10	87 A4R	86 A 5R	82 A9R	79 A12R	75 NC	71 CE 0R	66 OER	62 I/O _{15R}	58 I/O _{11R}	55 NC	51 I/O _{8R}	50 I/O7R
09	90 A 1R	88 A3R	85 A6R							52 NC	49 Vcc	47 I/O ₅ R
08	92 INT _R	91 A0R	89 A2R							48 I/O6R	46 I/O4R	45 I/O3R
07	95 GND	94 M/S	93 BUSYR			IDT70	-			44 I/O2R	43 I/O1R	42 I/O0R
06	96 BUSYL	97 INTL	98 NC	G108-1 ⁽⁴⁾ 108-Pin PGA Top View ⁽⁵⁾					39 I/O ₁ L	40 I/OoL	41 GND	
	99	100	102			Top V	iew ⁽⁵⁾			35	37	38
05	A ₀ L	A1L	A ₃ L							I/O ₄ L	I/O _{2L}	GND
04	101 A2L	103 A4L	106 A7L							31 Vcc	34 I/O ₅ L	36 I/O ₃ L
03	104 A 5L	105 A6L	1 A10L	4 A13L	8 NC	12 CE1L	17 GND	21 I/O14L	25 I/O10L	28 NC	32 I/O7L	33 I/O6L
02	107 A 8L	2 A11L	5 A14L	7 NC	10 UB L	13 SEML	16 OEL	19 GND	22 I/O13L	24 I/O11L	29 NC	30 I/O8L
01	108 A 9L	3 A12L	6 NC	9 LBL	11 CE ₀ L	14 Vcc	15 R/WL	18 NC	20 I/O _{15L}	23 I/O _{12L}	26 I/O9L	27 NC
1	Α	В	С	D	E	F	G	Н	J	K	L	M 3199 drw 03
INDEX												

NOTES:

- 1. All Vcc pins must be connected to power supply.
- 2. All GND pins must be connected to ground supply.
- 3. Package body is approximately 1.21 in x 1.21 in x .16 in.
- 4. This package code is used to reference the package diagram.
- 5. This text does not indicate orientation of the actual part-marking.

Pin Names

Left Port	Right Port	Names							
ŌĒ0L, CE1L	ŌĒ0R, CE1R	Chip Enables							
R/WL	R/W̄R	Read/Write Enable							
ŌĒL	OE R	Output Enable							
Aol - A14L	A0R - A14R	Address							
I/O0L - I/O15L	I/O0R - I/O15R	Data Input/Output							
SEML	<u>SEM</u> R	Semaphore Enable							
ŪB∟	ŪB̄R	Upper Byte Select							
LB L	LB R	Lower Byte Select							
ĪNTL	ĪNTr	Interrupt Flag							
BUSYL	BUS Y _R	Busy Flag							
M	ΙS̄	Master or Slave Select							
V	СС	Power							
G	ND	Ground							

Truth Table I - Chip Enable

CE	Œ	CE ₁	Mode		
	VıL	VIH	Port Selected (TTL Active)		
L	≤ 0.2V	≥Vcc -0.2V	Port Selected (CMOS Active)		
	Vн	X	Port Deselected (TTL Inactive)		
	X	VIL	Port Deselected (TTL Inactive)		
Н	≥Vcc -0.2V	X	Port Deselected (CMOS Inactive)		
	Х	≤0.2V	Port Deselected (CMOS Inactive)		

3199 tbl 02

NOTES:

- 1. Chip Enable references are shown above with the actual $\overline{\text{CE}}_0$ and CE_1 levels, $\overline{\text{CE}}$ is a reference only.
- 2. Port "A" and "B" references are located where $\overline{\text{CE}}$ is used.
- 3. "H" = VIH and "L" = VIL.

Truth Table II - Non-Contention Read/Write Control

		Inpu	uts ⁽¹⁾			Out	puts	
CE(2)	R/₩	ŌĒ	ŪB	ĪΒ	SEM	I/O8-15	I/O ₀₋₇	Mode
Н	Х	Х	Х	Х	Н	High-Z	High-Z	Deselected: Power-Down
Х	Х	Х	Н	Н	Н	High-Z	High-Z	Both Bytes Deselected
L	L	Х	L	Н	Н	DATAIN	High-Z	Write to Upper Byte Only
L	L	Х	Н	L	Н	High-Z	DATAIN	Write to Lower Byte Only
L	L	Х	L	L	Н	DATAIN	DATAIN	Write to Both Bytes
L	Н	L	L	Н	Н	DATAout	High-Z	Read Upper Byte Only
L	Н	L	Н	L	Н	High-Z	DATAout	Read Lower Byte Only
L	Н	L	L	L	Н	DATAout	DATAout	Read Both Bytes
Х	Х	Н	Х	Х	Х	High-Z	High-Z	Outputs Disabled

NOTES:

3199 tbl 03

- 1. AOL A14L \neq AOR A14R.
- 2. Refer to Chip Enable Truth Table.

Truth Table III - Semaphore Read/Write Control

	Inputs ⁽¹⁾					Out	puts	
CE ⁽²⁾	R/₩	ŌĒ	ŪB	ĪΒ	SEM	I/O8-15	I/O ₀₋₇	Mode
Н	Н	L	Х	Х	L	DATAout	DATAout	Read Data in Semaphore Flag
Х	Н	L	Н	Н	L	DATAout	DATAout	Read Data in Semaphore Flag
Н	1	Х	Х	Х	L	DATAIN	DATAIN	Write I/O₀ into Semaphore Flag
Х	1	Х	Н	Н	L	DATAIN	DATAIN	Write I/Oo into Semaphore Flag
Ĺ	Х	Х	L	Х	L			Not Allowed
L	Х	Х	Х	L	L			Not Allowed

NOTES:

- 1. There are eight semaphore flags written to via I/O₀ and read from all the I/O₅ (I/O₀ -I/O₁₅). These eight semaphore flags are addressed by A₀-A₂.
- 2. Refer to Chip Enable Truth Table.

Absolute Maximum Ratings(1,3)

Symbol	Rating	Commercial & Industrial	Military	Unit
VTERM ⁽²⁾	Terminal Voltage with Respect to GND	-0.5 to +7.0	-0.5 to +7.0	V
TBIAS	Temperature Under Bias	-55 to +125	-65 to +135	۰C
Tstg	Storage Temperature	-65 to +150	-65 to +150	۰C
Іоит	DC Output Current	50	50	mA

NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may
 cause permanent damage to the device. This is a stress rating only and
 functional operation of the device at these or any other conditions above those
 indicated in the operational sections of this specification is not implied. Exposure
 to absolute maximum rating conditions for extended periods may affect
 reliability.
- VTERM must not exceed Vcc + 10% for more than 25% of the cycle time or 10ns maximum, and is limited to ≤ 20mA for the period of VTERM ≥ Vcc + 10%.

Recommended DC Operating Conditions

Symbol	Parameter	Min.	Тур.	Max.	Unit
Vcc	Supply Voltage	4.5	5.0	5.5	V
GND	Ground	0	0	0	V
VIH	Input High Voltage	2.2	_	6.0(2)	V
VIL	Input Low Voltage	-0.5 ⁽¹⁾	_	0.8	V
					3199 tbl 07

NOTES:

- 1. $VIL \ge -1.5V$ for pulse width less than 10ns.
- 2. VTERM must not exceed Vcc + 10%.

Maximum Operating Temperature and Supply Voltage⁽¹⁾

		<u> </u>				
Grade	Ambient Temperature	GND	Vcc			
Military	-55°C to+125°C	0V	5.0V <u>+</u> 10%			
Commercial	0°C to +70°C	0V	5.0V <u>+</u> 10%			
Industrial	-40°C to +85°C	0V	5.0V <u>+</u> 10%			

NOTES:

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- 1. This is the parameter Ta. This is the "instant on" case temperature.
- Industrial temperature: for other speeds packages and powers, contact your sales office.

Capacitance⁽¹⁾

(TA = +25°C, f = 1.0mhz) TQFP ONLY

Symbol	Parameter	Conditions ⁽²⁾	Max.	Unit
CIN	Input Capacitance	VIN = 3dV	9	pF
Соит	Output Capacitance	Vout = 3dV	10	pF

NOTES:

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- This parameter is determined by device characterization but is not production tested.
- 3dV represents the interpolated capacitance when the input and output signals switch from 0V to 3V or from 3V to 0V.

DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range (Vcc = 5.0V ± 10%)

			7027S		702		
Symbol	Parameter	Test Conditions	Min.	Max.	Min.	Max.	Unit
ILI	Input Leakage Current ⁽¹⁾	Vcc = 5.5V, $Vin = 0V$ to Vcc	1	10	-	5	μA
ILO	Output Leakage Current	$\overline{CE} = V_{H}$, Vout = 0V to Vcc	_	10		5	μA
Vol	Output Low Voltage	Iol = 4mA	_	0.4	_	0.4	V
Voh	Output High Voltage	IOH = -4mA	2.4		2.4	_	V

NOTE:

1. At Vcc ≤ 2.0V, input leakages are undefined.

DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range^(1,6,7) (Vcc = 5.0V ± 10%)

	0 0 1 01 001 1 0 011	a cappiy toita	5 0		30	•		0.0	/	-,				
						7027X20 Com'l Only		7027X25 Com'l, Ind & Military		7027X35 Com'l & Military		7027X55 Com'l & Military		
Symbol	Parameter	Test Condition	Versi	on	Typ. ⁽²⁾	Max.	Typ. ⁽²⁾	Max.	Typ. ⁽²⁾	Max.	Typ. ⁽²⁾	Max.	Unit	
lcc	Dynamic Operating Current (Both Ports Active)	CE = V _{IL} , Outputs Disabled SEM = V _I H f = f _{MAX} (3)	COM'L	S L	185 185	325 285	180 170	305 265	160 160	295 255	150 150	270 230	mA	
	(Buil Folis Active)	T = IMAX*/	MIL & IND	S L	_	_	170 170	345 305	160 160	335 295	150 150	310 270		
ISB1	Standby Current (Both Ports - TTL Level Inputs)	<u>CEL</u> = <u>CER</u> = VIH SEMR = SEML = VIH f = fmax ⁽³⁾	COM'L	S L	55 55	90 70	40 40	85 60	30 30	85 60	20 20	85 60	mA	
	inpuis)	T = IMAX**	MIL & IND	S L	_	_	40 40	100 80	30 30	100 80	20 20	100 80		
ISB2	Standby Current (One Port - TTL Level Inputs)	\overline{CE} "A" = VIL and \overline{CE} "B" = VIH ⁽⁵⁾ Active Port Outputs Disabled, $f=f_{MAX}^{(3)}$	COM'L	S L	120 120	215 185	105 105	200 170	95 95	185 155	85 85	165 135	mA	
	ilipuis)	SEM _R = SEM _L = V _{IH}	MIL & IND	S L	1 1		105 105	230 200	95 95	215 185	85 85	195 165		
ISB3	Full Standby Current (Both Ports - All CMOS Level Inputs)	Both Ports \overline{CE}_L and $\overline{CE}_R \ge Vcc - 0.2V$ $VIN \ge Vcc - 0.2V$ or	COM'L	S L	1.0 0.2	15 5	1.0 0.2	15 5	1.0 0.2	15 5	1.0 0.2	15 5	mA	
	Level lilpuis)	$\frac{VIN \ge VCC - 0.2V}{SEM_R} = \frac{0}{SEML} \ge VCC - 0.2V$	MIL & IND	S L	_	_	1.0 0.2	30 10	1.0 0.2	30 10	1.0 0.2	30 10		
ISB4	Full Standby Current (One Port - All CMOS Level Inputs)	$\begin{array}{l} \overline{CE}^{\text{\tiny "}}A^{\text{\tiny "}} \leq 0.2 \text{V and} \\ \overline{CE}^{\text{\tiny "}}B^{\text{\tiny "}} \geq V\text{CC} - 0.2 \text{V}^{(5)} \\ \overline{\text{\tiny SEMR}} = \overline{\text{\tiny SEML}} \geq V\text{CC} - 0.2 \text{V} \end{array}$	COM'L	S L	115 115	190 160	100 100	170 145	90 90	160 135	80 80	135 110	mA	
		$VIN \ge VCC - 0.2\overline{V}$ or $VIN \le 0.2V$, Active Port Outputs Disable d, $f = fmax^{(3)}$	MIL & IND	S L	_	_	100 100	200 175	90 90	190 165	80 80	175 150		

NOTES:

1. 'X' in part numbers indicates power rating (S or L).

- 2. Vcc = 5V, TA = +25°C, and are not production tested. Iccpc = 120mA (Typ.)
- 3. At f = fmax, address and control lines (except Output Enable) are cycling at the maximum frequency read cycle of 1/ trc, and using "AC Test Conditions" of input levels of GND to 3V.
- 4. f = 0 means no address or control lines change.
- 5. Port "A" may be either left or right port. Port "B" is the opposite from port "A".
- 6. Refer to Chip Enable Truth Table.
- 7. Industrial temperature: for other speeds, packages and powers contact your sales office.

AC Test Conditions

dInput Pulse Levels	GND to 3.0V
Input Rise/Fall Times	5ns Max.
Input Timing Reference Levels	1.5V
Output Reference Levels	1.5V
Output Load	Figures 1 and 2

DATAOUT
BUSY
INT
347Ω

DATAOUT
347Ω

347Ω

347Ω

3199 drw 04

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Figure 1. AC Output Test Load

Figure 2. Output Test Load (for tLZ, tHZ, tWZ, tow) *Including scope and jig.

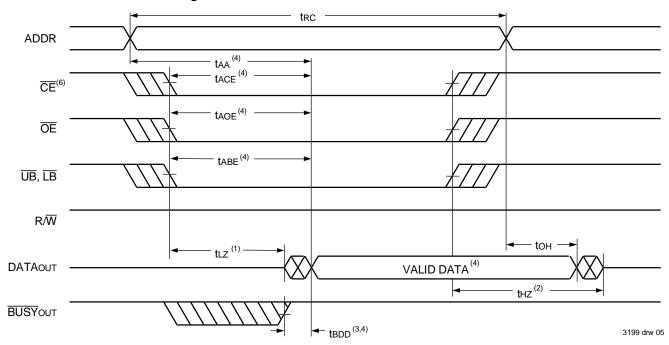
AC Electrical Characteristics Over the Operating Temperature and Supply Voltage Ranges^(4,6)

_	-		_	_						
		7027X20 Com'l Only		7027X25 Com'l, Ind. & Military		7027X35 Com'l & Military		7027X55 Com'l & Military		
Symbol	Parameter	Min.	Мах.	Min.	Мах.	Min.	Max.	Min.	Max.	Unit
READ CYCL	E									
trc	Read Cycle Time	20		25	_	35		55		ns
taa	Address Access Time	_	20		25	_	35		55	ns
tace	Chip Enable Access Time (3)	_	20		25	_	35		55	ns
tabe	Byte Enable Access Time ⁽³⁾		20		25	_	35	_	55	ns
taoe	Output Enable Access Time	_	12		13	_	20	_	30	ns
tон	Output Hold from Address Change	3		3	_	3		3	_	ns
t Lz	Output Low-Z Time ^(1,2)	3		3	_	3	_	3	_	ns
tHZ	Output High-Z Time ^(1,2)	_	12		15	_	15	_	25	ns
tPU	Chip Enable to Power Up Time (2,5)	0		0	_	0	_	0	_	ns
tPD	Chip Disable to Power Down Time ^(2,5)		20		25	_	35	_	50	ns
tsop	Semaphore Flag Update Pulse (OE or SEM)	10		12	_	15	_	15	_	ns
tsaa	Semaphore Address Access Time		20		25		35		55	ns

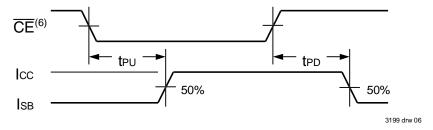
NOTES:.

- 1. Transition is measured 0mV from Low or High-impedance voltage with Output Test Load (Figure 2).
- 2. This parameter is guaranteed by device characterization, but is not production tested.
- 3. To access RAM, \overline{CE} = VIL and \overline{SEM} = VIH. To access semaphore, \overline{CE} = VIH and \overline{SEM} = VIL.
- 4. 'X' in part numbers indicates power rating (S or L).
- 5. Refer to Chip Enable Truth Table.
- 6. Industrial temperature: for other speeds, packages and powers contact your sales office.

Waveform of Read Cycles⁽⁵⁾



Timing of Power-Up Power-Down



- 1. Timing depends on which signal is asserted last, \overline{CE} , \overline{OE} , \overline{LB} , or \overline{UB} .
- 2. Timing depends on which signal is de-asserted first \overline{CE} , \overline{OE} , \overline{LB} , or \overline{UB} .
- 3. tepp delay is required only in cases where the opposite port is completing a write operation to the same address location. For simultaneous read operations BUSY has no relation to valid output data.
- 4. Start of valid data depends on which timing becomes effective last taoe, tace, taa or tBDD.
- 5. $\overline{\text{SEM}} = \text{ViH}$.
- 6. Refer to Chip Enable Truth Table.

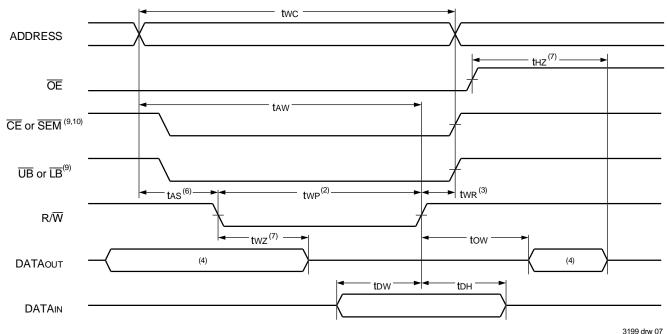
AC Electrical Characteristics Over the Operating Temperature and Supply Voltage (5,6)

		7027X20 Com'l Only		7027X25 Com'l, Ind & Military		7027X35 Com'l & Military		7027X55 Com'l & Military		
Symbol	Parameter	Min.	Мах.	Min.	Мах.	Min.	Max.	Min.	Мах.	Unit
WRITE CYC	LE									
twc	Write Cycle Time	20	_	25	_	35	_	55	_	ns
tew	Chip Enable to End-of-Write ⁽³⁾	15	_	20	_	30	_	45	_	ns
taw	Address Valid to End-of-Write	15		20	_	30	_	45	_	ns
tas	Address Set-up Time ⁽³⁾	0	_	0	_	0	_	0	_	ns
twp	Write Pulse Width	15	_	20	_	25	_	40	_	ns
twr	Write Recovery Time	0		0		0		0		ns
tow	Data Valid to End-of-Write	15	_	15	_	15	_	30	_	ns
tHZ	Output High-Z Time ^(1,2)	_	12	_	15	_	15	_	25	ns
tон	Data Hold Time ⁽⁴⁾	0	_	0	_	0	_	0	_	ns
twz	Write Enable to Output in High-Z ^(1,2)	_	12	_	15	_	15	_	25	ns
tow	Output Active from End-of-Write ^(1,2,4)	0		0		0	_	0		ns
tswrd	SEM Flag Write to Read Time	5	_	5		5	_	5	_	ns
tsps	SEM Flag Contention Window	5		5		5		5		ns

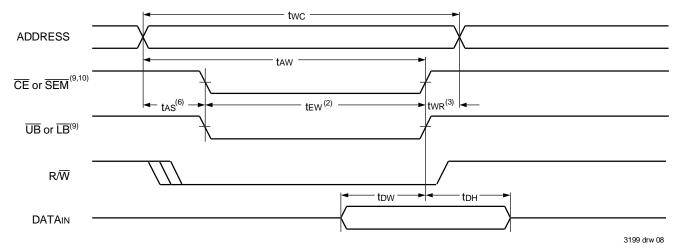
3199 tbl 13

- 1. Transition is measured 0mV from Low or High-impedance voltage with Output Test Load (Figure 2).
- This parameter is guaranteed by device characterization, but is not production tested.
 To access RAM CE= VIL and SEM = VIL. To access semaphore, CE = VIH and SEM = VIL. Either condition must be valid for the entire tew time. Refer to Chip Enable
- 4. The specification for ton must be met by the device supplying write data to the RAM under all operating conditions. Although ton and tow values will vary over voltage and temperature, the actual toH will always be smaller than the actual tow.
- 5. 'X' in part numbers indicates power rating (S or L).
- 6. Industrial temperature: for other speeds, packages and powers contact your sales office.

Timing Waveform of Write Cycle No. 1, R/W Controlled Timing(1,5,8)

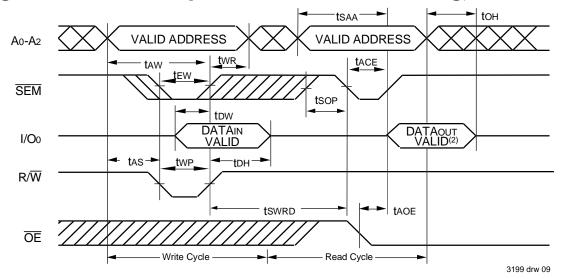


Timing Waveform of Write Cycle No. 2, $\overline{\text{CE}}$, $\overline{\text{UB}}$, $\overline{\text{LB}}$ Controlled Timing^(1,5)



- 1. R/\overline{W} or \overline{CE} or \overline{UB} and \overline{LB} = V_{IH} during all address transitions.
- 2. A write occurs during the overlap (tew or twp) of a \overline{CE} = VIL and a R/ \overline{W} = VIL for memory array writing cycle.
- 3. twn is measured from the earlier of $\overline{\text{CE}}$ or $\overline{\text{R/W}}$ (or $\overline{\text{SEM}}$ or $\overline{\text{R/W}}$) going HIGH to the end of write cycle.
- 4. During this period, the I/O pins are in the output state and input signals must not be applied.
- 5. If the $\overline{\text{CE}}$ or $\overline{\text{SEM}} = \text{VIL}$ transition occurs simultaneously with or after the $\overline{\text{RW}} = \text{VIL}$ transition, the outputs remain in the High-impedance state.
- 6. Timing depends on which enable signal is asserted last, $\overline{\text{CE}}$ or R/\overline{W} .
- 7. This parameter is guaranteed by device characterization, but is not production tested. Transition is measured 0mV from steady state with the Output Test Load (Figure 2).
- 8. If $\overline{OE} = V_{IL}$ during R/W controlled write cycle, the write pulse width must be the larger of twp or (twz + tow) to allow the I/O drivers to turn off and data to be placed on the bus for the required tow. If $\overline{OE} = V_{IH}$ during an R/W controlled write cycle, this requirement does not apply and the write pulse can be as short as the specified twp.
- 9. To access RAM, CE = VIL and SEM = VIH. To access semaphore, CE = VIH and SEM = VIL. tew must be met for either condition.
- 10. Refer to Chip Enable Truth Table.

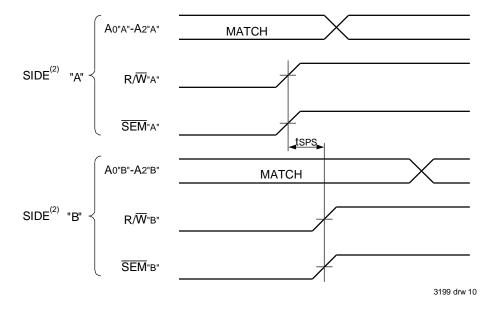
Timing Waveform of Semaphore Read after Write Timing, Either Side(1)



NOTES:

- 1. \overline{CE} = Vih or \overline{UB} and \overline{LB} = Vih for the duration of the above timing (both write and read cycle), refer to Chip Enable Truth Table.
- 2. "DATAOUT VALID" represents all I/O's (I/Oo-I/O15) equal to the semaphore value.

Timing Waveform of Semaphore Write Contention(1,3,4)



- 1. Dor = Dol = Vil, $\overline{CE}R = \overline{CE}L = VIH$, or both $\overline{UB} \& \overline{LB} = VIH$ (refer to Chip Enable Truth Table).
- 2. All timing is the same for left and right ports. Port "A" may be either left or right port. Port "B" is the opposite from port "A".
- 3. This parameter is measured from R\overline{W}^a\text{" or }\overline{SEM}^a\text{"a" going HIGH to }R\overline{W}^a\text{" or }\overline{SEM}^a\text{"b" or }\overline{SEM}^a\text{"b"
- 4. If tsps is not satisfied, there is no guarantee which side will be granted the semaphore flag.

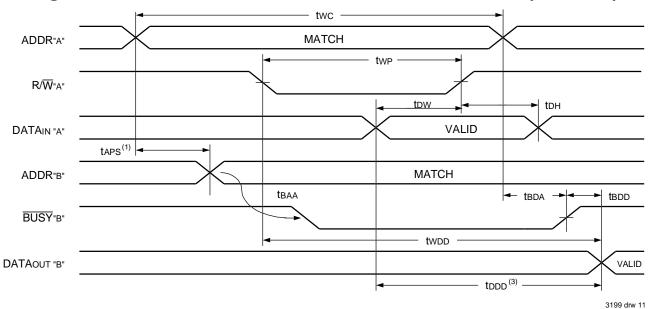
AC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range^(6,7)

	7027X20 Com'l Onl		7027X25 Com'l, Ind. & Military		7027X35 Com'l & Military		7027X55 Com'l & Military		
Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Unit
IG (M/S=Vih)									
BUSY Access Time from Address Match		20	_	20		20		45	ns
BUSY Disable Time from Address Not Matched		20	_	20		20	_	40	ns
BUSY Access Time from Chip Enable Low	_	20	_	20	_	20	_	40	ns
BUSY Access Time from Chip Enable High		17	_	17		20	_	35	ns
Arbitration Priority Set-up Time ⁽²⁾			5	_	5		5		ns
BUSY Disable to Valid Data ⁽³⁾	_	30	_	30	_	35	_	40	ns
Write Hold After BUSY ⁽⁵⁾	15	_	17	_	25		25	_	ns
IG (M/S=VIL)									
BUSY Input to Write (4)	0	-	0		0		0	_	ns
Write Hold After BUSY ⁵⁾	15		17		25		25	_	ns
PORT-TO-PORT DELAY TIMING									
Write Pulse to Data Delay ⁽¹⁾	_	45	_	50	_	60		80	ns
Write Data Valid to Read Data Delay ⁽¹⁾		30		35		45		65	ns
	BUSY Access Time from Address Match BUSY Disable Time from Address Not Matched BUSY Access Time from Chip Enable Low BUSY Access Time from Chip Enable High Arbitration Priority Set-up Time ⁽²⁾ BUSY Disable to Valid Data ⁽³⁾ Write Hold After BUSY ⁽⁵⁾ ORT DELAY TIMING Write Pulse to Data Delay ⁽¹⁾	Parameter Min. IG (M/\$=ViH) BUSY Access Time from Address Match BUSY Disable Time from Address Not Matched BUSY Access Time from Chip Enable Low BUSY Access Time from Chip Enable High Arbitration Priority Set-up Time ⁽²⁾ BUSY Disable to Valid Data ⁽³⁾ Write Hold After BUSY ⁽⁵⁾ IS ORT DELAY TIMING Write Pulse to Data Delay ⁽¹⁾ —— Min. Min. Min. Min. Min. Min. Min. Min. Min. Min. Min. Min. Min.	BUSY Access Time from Address Match 20	Parameter Min. Max. Min.	Parameter Min. Max. Min. Max.	Parameter Min. Max. Min. Max. Min. M	Parameter Min. Max. Min. Max. Min. Max. Min. Max. Min. Max.	Parameter Min. Max. Min. Max. Min. Max. Min. Max. Min. Max. Min. M	Parameter Com¹ Only & Min. Ind. & Military Com¹, Ind. & Military

3199 tbl 14

- 1. Port-to-port delay through RAM cells from writing port to reading port, refer to "Timing Waveform of Write with Port-to-Port Read and \overline{BUSY} (M/ \overline{S} = V_{IH})".
- 2. To ensure that the earlier of the two ports wins.
- 3. tbdd is a calculated parameter and is the greater of 0, twdd twp (actual), or tddd tdw (actual).
- 4. To ensure that the write cycle is inhibited on port "B" during contention on port "A".
- 5. To ensure that a write cycle is completed on port "B" after contention on port "A".
- 6. 'X' in part numbers indicates power rating (S or L).
- 7. Industrial temperature: for other speeds, packages and powers contact your sales office.

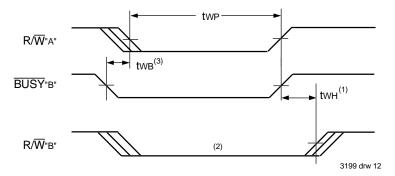
Timing Waveform of Write with Port-to-Port Read and \overline{BUSY} (M/ \overline{S} = VIH) $^{(2,4,5)}$



NOTES

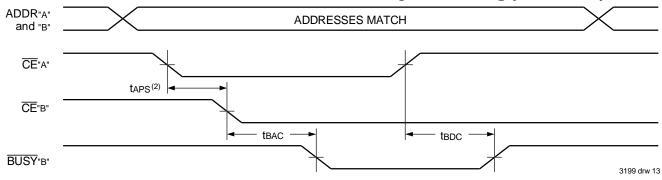
- 1. To ensure that the earlier of the two ports wins. taps is ignored for $M/\overline{S} = V_{IL}$ (slave).
- 2. $\overline{CE}_L = \overline{CE}_R = V_{IL}$ (refer to Chip Enable Truth Table).
- 3. \overline{OE} = VIL for the reading port.
- 4. If $M/\overline{S} = V_{IL}$ (slave), \overline{BUSY} is an input. Then for this example $\overline{BUSY}^*A^* = V_{IH}$ and \overline{BUSY}^*B^* input is shown above.
- 5. All timing is the same for left and right ports. Port "A" may be either the left or right port. Port "B" is the port opposite from port "A".

Timing Waveform of Write with \overline{BUSY} (M/ \overline{S} = VIL)

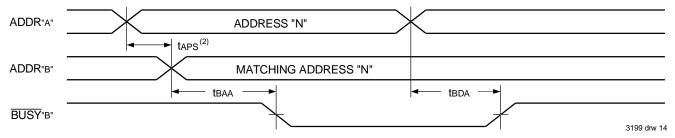


- 1. twh must be met for both BUSY input (SLAVE) and output (MASTER).
- 2. $\overline{\text{BUSY}}$ is asserted on port "B" blocking R/\overline{W} "B", until $\overline{\text{BUSY}}$ "B" goes HIGH.
- 3. twb is only for the "Slave" version.

Waveform of \overline{BUSY} Arbitration Controlled by \overline{CE} Timing (M/ \overline{S} = Vih)(1,3)



Waveform of \overline{BUSY} Arbitration Cycle Controlled by Address Match Timing (M/ \overline{S} = VIH)⁽¹⁾



NOTES:

- 1. All timing is the same for left and right ports. Port "A" may be either the left or right port. Port "B" is the port opposite from port "A".
- 2. If taps is not satisfied, the BUSY signal will be asserted on one side or another but there is no guarantee on which side BUSY will be asserted.
- 3. Refer to Chip Enable Truth Table.

AC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range^(1,2)

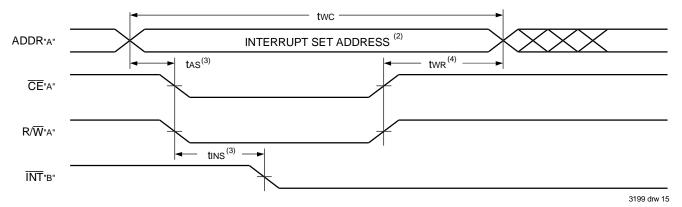
•	• •	•	•		•					
			7X20 I Only	7027X25 Com'l, Ind & Military		Com'l & Con		7X55 n'l & tary		
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Мах.	Min.	Max.	Unit
INTERRUPT	TIMING									
tas	Address Set-up Time	0		0		0		0	_	ns
twr	Write Recovery Time	0	_	0		0	_	0		ns
tins	Interrupt Set Time	_	20		20		25	_	40	ns
tinr	Interrupt Reset Time	_	20		20		25	_	40	ns

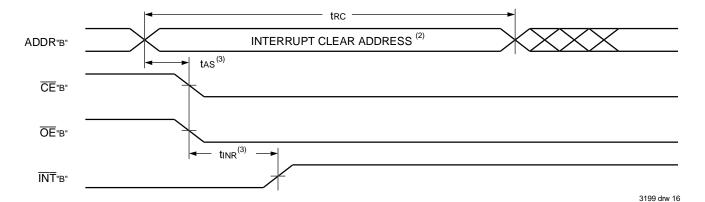
NOTES:

1. 'X' in part numbers indicates power rating (S or L).

2. Industrial temperature: for other speeds, packages and powers contact your sales office.

Waveform of Interrupt Timing(1,5)





NOTES:

- 1. All timing is the same for left and right ports. Port "A" may be either the left or right port. Port "B" is the port opposite from port "A".
- 2. See the Interrupt Truth Table IV.
- 3. Timing depends on which enable signal $(\overline{CE} \text{ or } R/\overline{W})$ is asserted last.
- 4. Timing depends on which enable signal $(\overline{CE} \text{ or } R/\overline{W})$ is de-asserted first.
- 5. Refer to Chip Enable Truth Table.

Truth Table IV — Interrupt Flag^(1,4)

		Left Port								
R/WL	CEL	ŌĒL	A14L-A0L	ĪNTL	R/W̄R	CER	OE R	A 14R -A 0R	ĪNTR	Function
L	L	Х	7FFF	Х	Х	Х	Х	Х	L ⁽²⁾	Set Right INTR Flag
Х	Х	Х	Х	Х	Х	L	L	7FFF	H ⁽³⁾	Reset Right INTR Flag
Х	Х	Х	Х	L ⁽³⁾	L	L	Х	7FFE	Х	Set Left INTL Flag
Х	L	L	7FFE	H ⁽²⁾	Х	Х	Х	Х	Х	Reset Left INT _L Flag

NOTES:

- 1. Assumes $\overline{BUSY}L = \overline{BUSY}R = VIH$.
- 2. If $\overline{BUSY}L = VIL$, then no change.
- 3. If $\overline{BUSY}R = VIL$, then no change.
- 4. Refer to Chip Enable Truth Table.

Truth Table V — Address Bus Arbitration⁽⁴⁾

	In	puts	Out		
ΕĒL	ՇĒ R	Aol-A14L Aor-A14r	BUSY _L (1)	BUSY _R (1)	Function
Х	Χ	NO MATCH	Н	Н	Normal
Н	Χ	MATCH	Н	Н	Normal
Х	Н	MATCH	Н	Н	Normal
L	L	MATCH	(2)	(2)	Write Inhibit ⁽³⁾

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NOTES:

- 1. Pins BUSYL and BUSYR are both outputs when the part is configured as a master. Both are inputs when configured as a slave. BUSY outputs on the IDT7027 are push-pull, not open drain outputs. On slaves the BUSY input internally inhibits writes.
- 2. "L" if the inputs to the opposite port were stable prior to the address and enable inputs of this port. "H" if the inputs to the opposite port became stable after the address and enable inputs of this port. If taps is not met, either BUSYL or BUSYR = LOW will result. BUSYL and BUSYR outputs can not be LOW simultaneously.
- 3. Writes to the left port are internally ignored when BUSYL outputs are driving LOW regardless of the actual logic level on the pin. Writes to the right port are internally ignored when BUSYR outputs are driving LOW regardless of the actual logic level on the pin.
- 4. Refer to Chip Enable Truth Table.

Truth Table VI — Example of Semaphore Procurement Sequence (1,2,3)

Functions	Do - D15 Left	Do - D15 Right	Status
No Action	1	1	Semaphore free
Left Port Writes "0" to Semaphore	0	1	Left port has semaphore token
Right Port Writes "0" to Semaphore	0	1	No change. Right side has no write access to semaphore
Left Port Writes "1" to Semaphore	1	0	Right port obtains semaphore token
Left Port Writes "0" to Semaphore	1	0	No change. Left port has no write access to semaphore
Right Port Writes "1" to Semaphore	0	1	Left port obtains semaphore token
Left Port Writes "1" to Semaphore	1	1	Semaphore free
Right Port Writes "0" to Semaphore	1	0	Right port has semaphore token
Right Port Writes "1" to Semaphore	1	1	Semaphore free
Left Port Writes "0" to Semaphore	0	1	Left port has semaphore token
Left Port Writes "1" to Semaphore	1	1	Semaphore free

NOTES: 3199 tol 18

- 1. This table denotes a sequence of events for only one of the eight semaphores on the IDT7027.
- 2. There are eight semaphore flags written to via I/O0 and read from all the I/O's (I/O0-I/O1s). These eight semaphores are addressed by Ao-A2.
- 3. $\overline{\text{CE}} = \text{VIH}$, $\overline{\text{SEM}} = \text{VIL}$, to access the semaphores. Refer to the Semaphore Read/Write Control Truth Table.

Functional Description

The IDT7027 provides two ports with separate control, address and I/O pins that permit independent access for reads or writes to any location in memory. The IDT7027 has an automatic power down feature controlled by $\overline{\text{CE}}_0$ and CE1. The $\overline{\text{CE}}_0$ and CE1 control the on-chip power down circuitry that permits the respective port to go into a standby mode when not selected ($\overline{\text{CE}}$ = VIH). When a port is enabled, access to the entire memory array is permitted.

Interrupts

If the user chooses the interrupt function, a memory location (mail box or message center) is assigned to each port. The left port interrupt flag

($\overline{\text{INTL}}$) is asserted when the right port writes to memory location 7FFE (HEX), where a write is defined as $\overline{\text{CE}}_R = R/\overline{W}_R = \text{VIL}$ per Truth Table IV. The left port clears the interrupt through access of address location 7FFE when $\overline{\text{CE}}_L = \overline{\text{OE}}_L = \text{VIL}$, $R/\overline{\text{W}}$ is a "don't care". Likewise, the right port interrupt flag ($\overline{\text{INTR}}$) is asserted when the left port writes to memory location 7FFF (HEX) and to clear the interrupt flag ($\overline{\text{INTR}}$), the right port must read the memory location 7FFF. The message (16 bits) at 7FFE or 7FFF is user-defined since it is an addressable SRAM location. If the interrupt function is not used, address locations 7FFE and 7FFF are not used as mail-boxes by ignoring the interrupt, but as part of the random access memory. Refer to Truth Table IV for the interrupt operation.

Busy Logic

Busy Logic provides a hardware indication that both ports of the RAM have accessed the same location at the same time. It also allows one of the two accesses to proceed and signals the other side that the RAM is "Busy". The $\overline{\text{BUSY}}$ pin can then be used to stall the access until the operation on the other side is completed. If a write operation has been attempted from the side that receives a $\overline{\text{BUSY}}$ indication, the write signal is gated internally to prevent the write from proceeding.

The use of \overline{BUSY} logic is not required or desirable for all applications. In some cases it may be useful to logically OR the \overline{BUSY} outputs together and use any \overline{BUSY} indication as an interrupt source to flag the event of an illegal or illogical operation. If the write inhibit function of busy logic is not desirable, the \overline{BUSY} logic can be disabled by placing the part in slave mode with the M/\overline{S} pin. Once in slave mode the \overline{BUSY} pin operates solely as a write inhibit input pin. Normal operation can be programmed by tying the \overline{BUSY} pins HIGH. If desired, unintended write operations can be prevented to a port by tying the BUSY pin for that port LOW.

The BUSY outputs on the IDT7027 RAM in master mode, are pushpull type outputs and do not require pull up resistors to operate. If these RAMs are being expanded in depth, then the BUSY indication for the resulting array requires the use of an external AND gate.

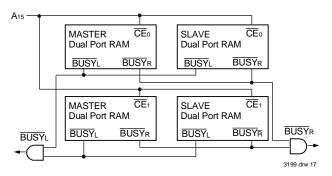


Figure 3. Busy and chip enable routing for both width and depth expansion with IDT7027 RAMs.

Width Expansion with Busy Logic Master/Slave Arrays

When expanding an IDT7027 RAM array in width while using \overline{BUSY} logic, one master part is used to decide which side of the RAM array will receive a \overline{BUSY} indication, and to output that indication. Any number of slaves to be addressed in the same address range as the master, use the \overline{BUSY} signal as a write inhibit signal. Thus on the IDT7027 RAM the \overline{BUSY} pin is an output if the part is used as a Master (M/ \overline{S} pin = VIH), and the \overline{BUSY} pin is an input if the part used as a Slave (M/ \overline{S} pin = VIL) as shown in Figure 3.

If two or more master parts were used when expanding in width, a split decision could result with one master indicating BUSY on one side of the array and another master indicating BUSY on one other side of the array. This would inhibit the write operations from one port for part of a word and inhibit the write operations from the other port for the other part of the word.

The BUSY arbitration, on a master, is based on the chip enable and address signals only. It ignores whether an access is a read or write. In a master/slave array, both address and chip enable must be valid long enough for a BUSY flag to be output from the master before the actual write

pulse can be initiated with either the R/\overline{W} signal or the byte enables. Failure to observe this timing can result in a glitched internal write inhibit signal and corrupted data in the slave.

Semaphores

The IDT7027 is a fast Dual-Port 32K x 16 CMOS Static RAM with an additional 8 address locations dedicated to binary semaphore flags. These flags allow either processor on the left or right side of the Dual-Port SRAM to claim a privilege over the other processor for functions defined by the system designer's software. As an example, the semaphore can be used by one processor to inhibit the other from accessing a portion of the Dual-Port SRAM or any other shared resource.

The Dual-Port SRAM features a fast access time, and both ports are completely independent of each other. This means that the activity on the left port in no way slows the access time of the right port. Both ports are identical infunction to standard CMOS Static RAM and can be read from, or written to, at the same time with the only possible conflict arising from the simultaneous writing of, or a simultaneous READ/WRITE of, a non-semaphore location. Semaphores are protected against such ambiguous situations and may be used by the system program to avoid any conflicts in the non-semaphore portion of the Dual-Port SRAM. These devices have an automatic power-down feature controlled by $\overline{\text{CE}}$ the Dual-Port SRAM enable, and $\overline{\text{SEM}}$, the semaphore enable. The $\overline{\text{CE}}$ and $\overline{\text{SEM}}$ pins control on-chip power down circuitry that permits the respective port to go into standby mode when not selected. This is the condition which is shown in Truth Table II where $\overline{\text{CE}}$ and $\overline{\text{SEM}} = \text{VIH}$.

Systems which can best use the IDT7027 contain multiple processors or controllers and are typically very high-speed systems which are software controlled or software intensive. These systems can benefit from a performance increase offered by the IDT7027's hardware semaphores, which provide a lockout mechanism without requiring complex programming.

Software handshaking between processors offers the maximum in system flexibility by permitting shared resources to be allocated in varying configurations. The IDT7027 does not use its semaphore flags to control any resources through hardware, thus allowing the system designer total flexibility in system architecture.

An advantage of using semaphores rather than the more common methods of hardware arbitration is that wait states are never incurred in either processor. This can prove to be a major advantage in very high-speed systems.

How the Semaphore Flags Work

The semaphore logic is a set of eight latches which are independent of the Dual-Port SRAM. These latches can be used to pass a flag, or token, from one port to the other to indicate that a shared resource is in use. The semaphores provide a hardware assist for a use assignment method called "Token Passing Allocation." In this method, the state of a semaphore latch is used as a token indicating that shared resource is in use. If the left processor wants to use this resource, it requests the token by setting the latch. This processor then verifies its success in setting the latch by reading it. If it was successful, it proceeds to assume control over the shared resource. If it was not successful in setting the latch, it determines that the right side processor has set the latch first, has the token and is using the shared resource. The left processor can then either repeatedly request that semaphore's status or remove its request for that semaphore to

perform another task and occasionally attempt again to gain control of the token via the set and test sequence. Once the right side has relinquished the token, the left side should succeed in gaining control.

The semaphore flags are active low. A token is requested by writing a zero into a semaphore latch and is released when the same side writes a one to that latch.

The eight semaphore flags reside within the IDT7027 in a separate memory spacefrom the Dual-Port SRAM. This address space is accessed by placing a low input on the \overline{SEM} pin (which acts as a chip select for the semaphore flags) and using the other control pins (Address, \overline{OE} , and R/\overline{W}) as they would be used in accessing a standard Static RAM. Each of the flags has a unique address which can be accessed by either side through address pins A0 – A2. When accessing the semaphores, none of the other address pins has any effect.

When writing to a semaphore, only data pin Do is used. If a LOW level is written into an unused semaphore location, that flag will be set to a zero on that side and a one on the other side (see Truth Table VI). That semaphore can now only be modified by the side showing the zero. When a one is written into the same location from the same side, the flag will be set to a one for both sides (unless a semaphore request from the other side is pending) and then can be written to by both sides. The fact that the side which is able to write a zero into a semaphore subsequently locks out writes from the other side is what makes semaphore flags useful in interprocessor communications. (A thorough discussion on the use of this feature follows shortly.) A zero written into the same location from the other side will be stored in the semaphore request latch for that side until the semaphore is freed by the first side.

When a semaphore flag is read, its value is spread into all data bits so that a flag that is a one reads as a one in all data bits and a flag containing a zero reads as all zeros. The read value is latched into one side's output register when that side's semaphore select (\overline{SEM}) and output enable (\overline{OE}) signals go active. This serves to disallow the semaphore from changing state in the middle of a read cycle due to a write cycle from the other side. Because of this latch, a repeated read of a semaphore in a test loop must cause either signal (\overline{SEM}) or \overline{OE} to go inactive or the output will never change.

A sequence WRITE/READ must be used by the semaphore in order to guarantee that no system level contention will occur. A processor requests access to shared resources by attempting to write a zero into a semaphore location. If the semaphore is already in use, the semaphore request latch will contain a zero, yet the semaphore flag will appear as one, a fact which the processor will verify by the subsequent read (see Truth Table VI). As an example, assume a processor writes a zero to the left port at a free semaphore location. On a subsequent read, the processor will verify that it has written successfully to that location and will assume control over the resource in question. Meanwhile, if a processor on the right side attempts to write a zero to the same semaphore flag it will fail, as will be verified by the fact that a one will be read from that semaphore on the right

side during subsequent read. Had a sequence of READ/WRITE been used instead, system contention problems could have occurred during the gap between the read and write cycles.

It is important to note that a failed semaphore request must be followed by either repeated reads or by writing a one into the same location. The reason for this is easily understood by looking at the simple logic diagram of the semaphore flag in Figure 4. Two semaphore request latches feed into a semaphore flag. Whichever latch is first to present a zero to the

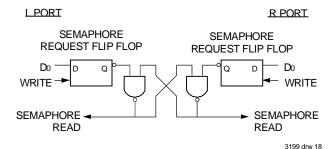


Figure 4. IDT7027 Semaphore Logic

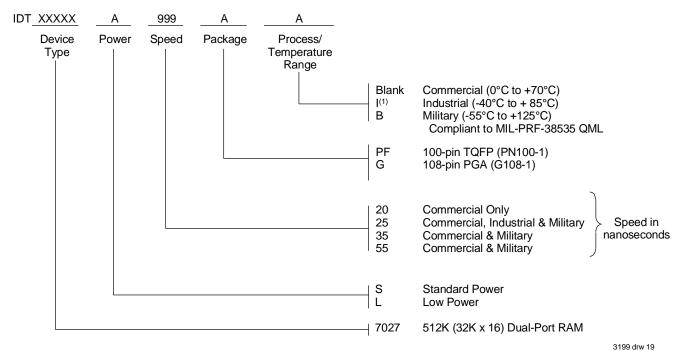
semaphore flag will force its side of the semaphore flag LOW and the other side HIGH. This condition will continue until a one is written to the same semaphore request latch. Should the other side's semaphore request latch have been written to a zero in the meantime, the semaphore flag will flip over to the other side as soon as a one is written into the first side's request latch. The second side's flag will now stay LOW until its semaphore request latch is written to a one. From this it is easy to understand that, if a semaphore is requested and the processor which requested it no longer needs the resource, the entire system can hang up until a one is written into that semaphore request latch.

The critical case of semaphore timing is when both sides request a single token by attempting to write a zero into it at the same time. The semaphore logic is specially designed to resolve this problem. If simultaneous requests are made, the logic guarantees that only one side receives the token. If one side is earlier than the other in making the request, the first side to make the request will receive the token. If both requests arrive at the same time, the assignment will be arbitrarily made to one port or the other.

One caution that should be noted when using semaphores is that semaphores alone do not guarantee that access to a resource is secure. As with any powerful programming technique, if semaphores are misused or misinterpreted, a software error can easily happen.

Initialization of the semaphores is not automatic and must be handled via the initialization program at power-up. Since any semaphore request flag which contains a zero must be reset to a one, all semaphores on both sides should have a one written into them at initialization from both sides to assure that they will be free when needed.

Ordering Information



NOTE:

Industrial temperature range is available on selected TQFP packages in standard power.
 For other speeds, packages and powers contact your sales office.

Datasheet Document History

1/15/99: Initiated datasheet document history

Converted to new format

Cosmetic and typographical corrections

Pages 2 and 3 Added additional notes to pin configurations

5/19/99: Pages 4 and 16 Fixed typographical errors

6/3/99: Changed drawing format

Page 1 Corrected DSC number

11/10/99: Replaced IDT logo

5/22/00: Page 5 Increased storage temperature parameter

Clarified TA parameter

Page 6 DC Electrical parameters-changed wording from "open" to "disabled"

Changed ±200mV to 0mV in notes



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